

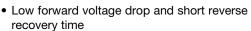
Fast Soft Recovery Rectifier Diode, 80 A

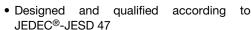


PRIMARY CHARACTERISTICS						
I _{F(AV)}	80 A					
V_{R}	200 V, 400 V, 600 V					
V _F at I _F	1.25 V					
I _{FSM}	1000 A					
t _{rr}	70 ns					
T _J max.	150 °C					
Package	TO-247AC 3L					
Circuit configuration	Single					
Snap factor	0.5					

FEATURES

- Glass passivated pellet chip junction
- 150 °C max. operating junction temperature





 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

These devices are intended for use in output rectification and freewheeling in inverters, choppers and converters as well as in input rectification where severe restrictions on conducted EMI should be met.

DESCRIPTION

The VS-90APF006L-M3 soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS							
SYMBOL CHARACTERISTICS VALUES UNITS							
V _{RRM}		200 to 600	V				
I _{F(AV)}	Sinusoidal waveform	80	^				
I _{FSM}		1000	A				
t _{rr}	1 A, - 100 A/µs	70	ns				
V _F	40 A, T _J = 25 °C	1.1	V				
T _J	Range	-40 to +150	°C				

VOLTAGE RATINGS							
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA				
VS-80APF02-M3	200	300					
VS-80APF04-M3	400	500	17				
VS-80APF06-M3	600	700					



ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum average forward current	I _{F(AV)}	$T_C = 95$ °C, 180° conduction half sine wave	80			
Maximum peak one cycle non-repetitive surge current	I _{FSM}	10 ms sine pulse, rated V _{RRM} applied	850	А		
		10 ms sine pulse, no voltage reapplied	1000			
Maximum I ² t for fusing	l ² t	10 ms sine pulse, rated V _{RRM} applied	3610	A ² s		
Maximum I-t for fusing	1-1	10 ms sine pulse, no voltage reapplied	5100	A-S		
Maximum l ² √t for fusing	I²√t	t = 0.1 ms to 10 ms, no voltage reapplied	51 000	A²√s		

ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS		
Maximum forward voltage drop	V_{FM}	80 A, T _J = 25 °C		1.25	V		
Forward slope resistance	r _t	T 450 00		3.5	mΩ		
Threshold voltage	V _{F(TO)}	T _J = 150 °C	0.85	V			
Maximum reverse leakage current	I	T _J = 25 °C	V _B = Rated V _{BBM}	0.1	mA		
iviaximum reverse leakage current	IRM	T _J = 150 °C	VR = nateu VRRM	17	IIIA		

RECOVERY CHARACTERISTICS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Reverse recovery time	t _{rr}	Is at 40 Apr	190	ns	I _{FM} t		
Reverse recovery current	I _{rr}	I _F at 40 A _{pk} 25 Α/μs	3.4	Α			
Reverse recovery charge	Q _{rr}	25 °C	0.5	μC	di / Q,,		
Snap factor	S		0.5		I _{RM(REC)}		

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and sto temperature range	orage	T _J , T _{Stg}		-40 to +150	°C	
Maximum thermal resistar junction to case	nce,	R _{thJC}	DC operation	0.35		
Maximum thermal resistar junction to ambient	Maximum thermal resistance, junction to ambient			40	°C/W	
Typical thermal resistance case to heatsink	Typical thermal resistance, case to heatsink		Mounting surface, smooth and greased	0.2		
Approximate weight				6	g	
Approximate weight				0.21	oz.	
Manustina taurus	minimum			6 (5)	kgf · cm	
Wounting torque —	Mounting torque maximum			12 (10)	(lbf ⋅ in)	
				80APF02		
Marking device	Marking device		Case style TO-247AC 3L	80AF	PF04	
				80AF	80APF06	

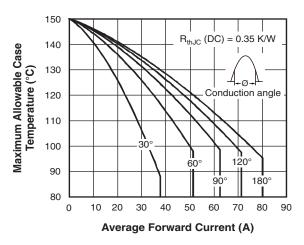


Fig. 1 - Current Rating Characteristics

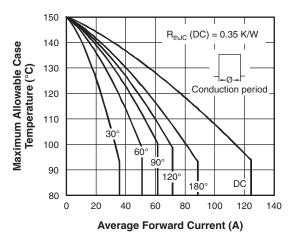


Fig. 2 - Current Rating Characteristics

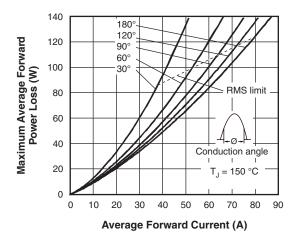


Fig. 3 - Forward Power Loss Characteristics

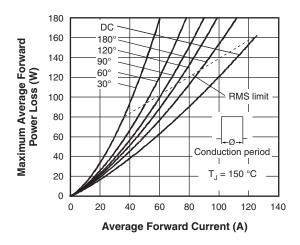


Fig. 4 - Forward Power Loss Characteristics

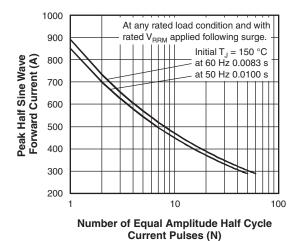


Fig. 5 - Maximum Non-Repetitive Surge Current

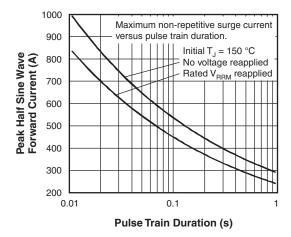


Fig. 6 - Maximum Non-Repetitive Surge Current

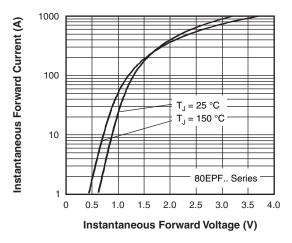


Fig. 7 - Forward Voltage Drop Characteristics

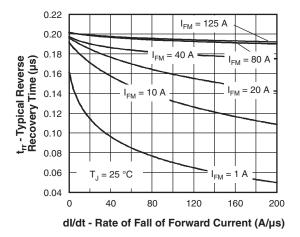


Fig. 8 - Recovery Time Characteristics, $T_J = 25$ °C

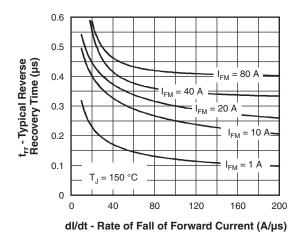


Fig. 9 - Recovery Time Characteristics, $T_J = 150 \, ^{\circ}\text{C}$

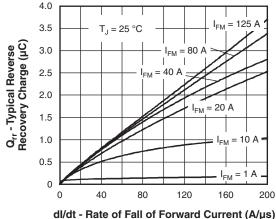
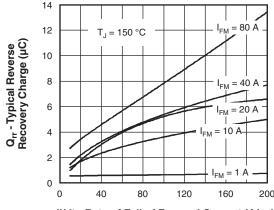


Fig. 10 - Recovery Charge Characteristics, $T_J = 25$ °C



dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 11 - Recovery Charge Characteristics, T_J = 150 °C

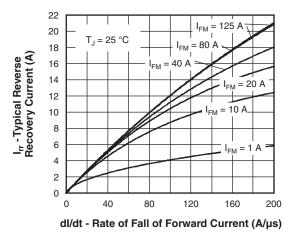


Fig. 12 - Recovery Current Characteristics, $T_J = 25$ °C

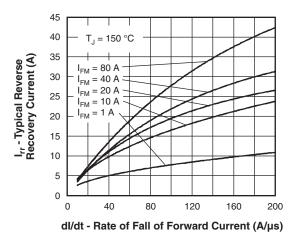


Fig. 13 - Recovery Current Characteristics, T_J = 150 °C

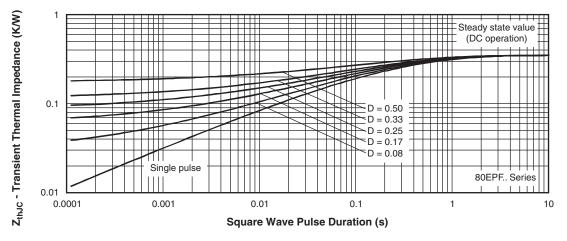
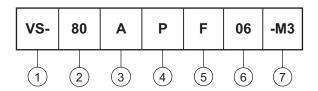


Fig. 14 - Thermal Impedance Z_{thJC} Characteristics



ORDERING INFORMATION TABLE

Device code



Vishay Semiconductors product

Current rating (80 = 80 A)

Circuit configuration:

A = single diode, 3 pins

4 Package:

P = TO-247AC 3L

5 Type of silicon:

F = fast recovery

02 = 200 V

6 Voltage code x $100 = V_{RRM}$

04 = 400 V

Environmental digit:

06 = 600 V

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-80APF02-M3	25	500	Antistatic plastic tubes				
VS-80APF04-M3	25	500	Antistatic plastic tubes				
VS-80APF06-M3	25	500	Antistatic plastic tubes				

LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?96138</u>					
Part marking information	www.vishay.com/doc?95007				



TO-247AC 3L

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	IETERS	INCHES		NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS		INCHES		NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.35	0.020	0.053	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØK	0.254		0.0)10	
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217	BSC	
	·		·	·	·

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension Q



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Vishay

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